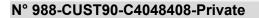
Process / Product Change Notification





Dear Customer,

Please find attached our INFINEON Technologies PCN:

Additional wafer fab site and new assembly site for PDIP package only

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 21-May-2017.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0 Chairman of the Supervisory Board: Wolfgang Mayrhuber Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck Registered Office: Neubiberg Commercial Register Amtsgericht München HRB 126492

Process / Product Change Notification

N° 988-CUST90-C4048408-Private



Additional wafer fab site and new assembly site for PDIP package only

Products affected:

See attached for affected parts.

Detailed Change Information:

Subject: Transfer of wafer fabrication processing from Newport, Wales to NXP Oak Hill. For the PDIP package only, JCET China is also being added as a new assembly location.
 Reason: As part of a manufacturing consolidation plan announced in March 2015, Infineon indicated that it would be closing the Fab11 facility and transferring the production capability for certain parts to established SiFo partners.
 Description: Additional wafer fab site and new assembly site for PDIP package only

As the result of this change

		OLD		NEW	
	Wafer Fab Location Infineon Technologies N		Newport Limited	NXP Oak Hill, Austin Texas, US and Infineon Technologies Newport Limited	
	Assembly (PDIP Only)	sembly (PDIP Only) Carsem Malaysia and Hana Thailand		JCET China and Hana Thailand	
however,			sed on the ass	e distinguished through the external part marking or shipping labels, embly lot code and marked on the device. IFX internal systems will the wafer lots used to produce the final product.	
► Ir	npact of Change:	specification	No changes to form, fit, or function. The package outline remains the same. Datasheet specifications will not be changed. The package bill of material and the location for assembly and final test will not change.		
► Attachments: 9		988-CUST90	988-CUST90-C4048408-AffectedParts.xlsx		
► Time Schedule:					
Final qualification report:		Available			
 First samples available: 			On Request		
Int	ended start of delivery:		20-July-2017		

If you have any questions, please do not hesitate to contact your local Sales office.